Medium Power Transistor (32V, 1A)

2SD1858

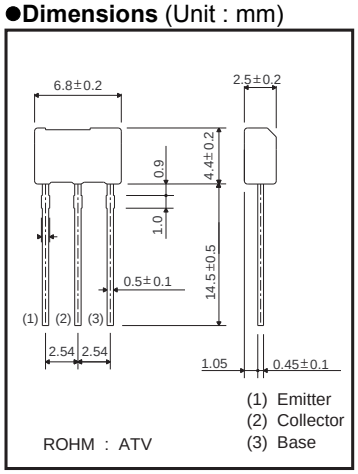
●Features

1) Low $V_{CE(sat)}$ = 0.15V(Typ.)
(I_C / I_B = 500mA / 50mA)
2) Compliments 2SB1237

●Structure

Epitaxial planar type
NPN silicon transistor

●Dimensions (Unit : mm)



●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V_{CBO}	40	V
Collector-emitter voltage	V_{CEO}	32	V
Emitter-base voltage	V_{EBO}	5	V
Collector current	I_C	1	A (DC)
		2	A (Pulse) ∗1
Collector power dissipation	P_C	1	W ∗2
Junction temperature	Tj	150	°C
Storage temperature	Tstg	−55 to +150	°C

∗1 Pw=20ms, duty=1/2
∗2 When it is mounted on the copper clad PCB (1.7mm thick) with land size for collector 1 square CM or larger.

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV_{CBO}	40	—	—	V	I_C=50μA
Collector-emitter breakdown voltage	BV_{CEO}	32	—	—	V	I_C=1mA
Emitter-base breakdown voltage	BV_{EBO}	5	—	—	V	I_E=50μA
Collector cutoff current	I_{CBO}	—	—	0.5	μA	V_{CB}=20V
Emitter cutoff current	I_{EBO}	—	—	0.5	μA	V_{EB}=4V
DC current transfer ratio	h_{FE}	120	—	390	—	V_{CE}=3V, I_C=100mA
Collector-emitter saturation voltage	$V_{CE(sat)}$	—	0.15	0.4	V	I_C/I_B=500mA / 50mA
Transition frequency	f_T	—	150	—	MHz	V_{CE}=5V, I_E= −50mA, f=100MHz
Output capacitance	Cob	—	15	—	pF	V_{CB}=10V, I_E=0A, f=1MHz

●Packaging specifications and h_{FE}

Type	h_{FE}	Package	Taping
		Code	TV2
		Basic ordering unit (pieces)	2500
2SD1858	QR		○

h_{FE} values are classified as follows :

Item	Q	R
h_{FE}	120 to 270	180 to 390

●Electrical characteristics curves

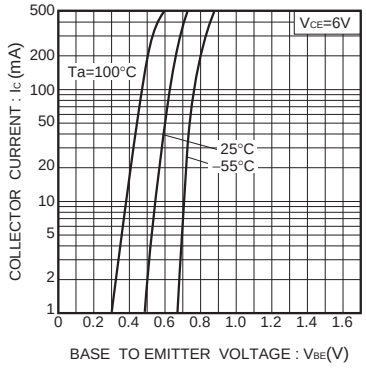


Fig.1 Grounded emitter propagation characteristics

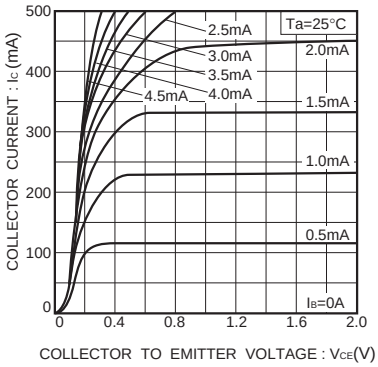


Fig.2 Grounded emitter output characteristics

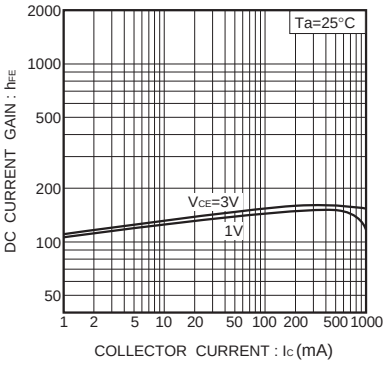


Fig.3 DC current gain vs. collector current (I)

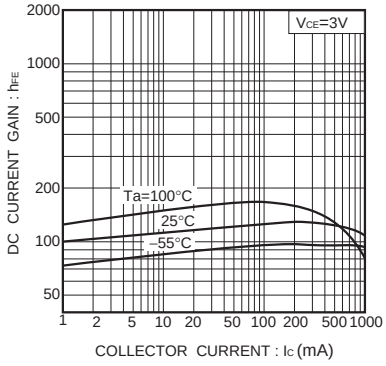


Fig.4 DC current gain vs. collector current (II)

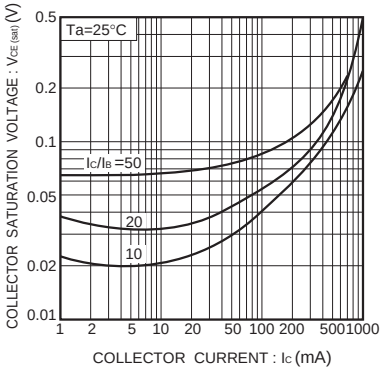


Fig.5 Collector-emitter saturation voltage vs. collector current (I)

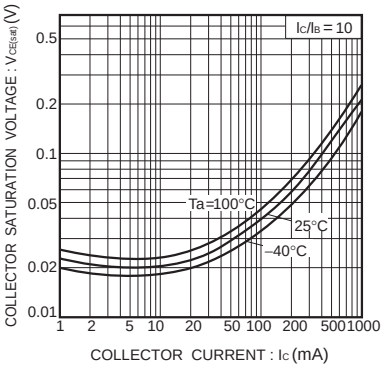


Fig.6 Collector-emitter saturation voltage vs. collector current (II)

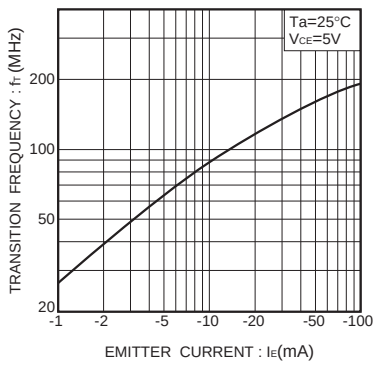


Fig.7 Gain bandwidth product vs. emitter current

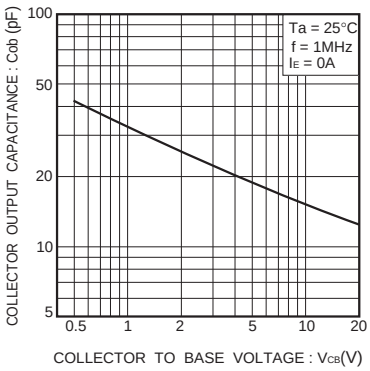


Fig.8 Collector output capacitance vs. collector-base voltage

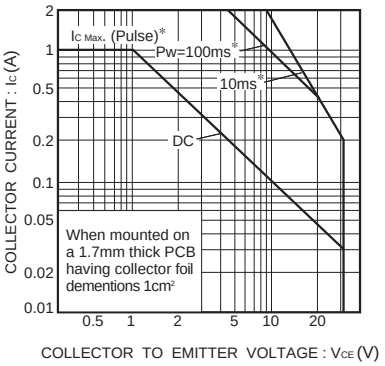


Fig.9 Safe operating area

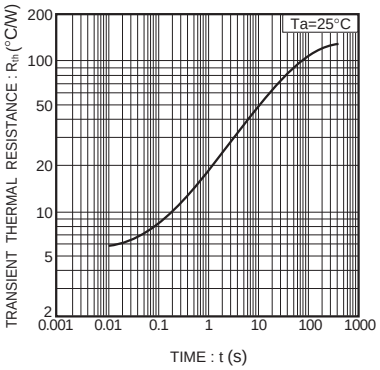


Fig.10 Transient thermal resistance

Notes

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